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Fairchild Semiconductor FDPF680N10T

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November 2013

FDPF680N10T

N-Channel PowerTrench $^{\mbox{\scriptsize R}}$ MOSFET 100 V, 12 A, 68 m Ω

Features

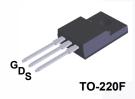
- $R_{DS(on)}$ = 54 m Ω (Typ.) @ V_{GS} = 10 V, I_D = 6 A
- · Fast Switching Speed
- · Low Gate Charge
- High Performance Trench Technology for Extremely Low $R_{\ensuremath{\mathsf{DS}}(\mathsf{on})}$
- · High Power and Current Handling Capability
- · RoHS Compliant

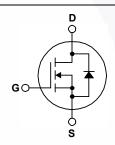
Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advance PowerTrench® process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

Applications

- · Consumer Appliances
- LCD/LED/PDP TV
- · Synchronous Rectification
- · Uninterruptible Power Supply
- · Micro Solar Inverter





MOSFET Maximum Ratings $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol		Parameter	FDPF680N10T	Unit	
V_{DSS}	Drain to Source Voltage	Drain to Source Voltage			V
V_{GSS}	Gate to Source Voltage			±20	V
_	Drain Current	- Continuous (T _C = 25°C)		12	А
ID	- Continuous (T _C = 100°C)			7.6	_ ^
I _{DM}	Drain Current	- Pulsed	- Pulsed (Note 1)		Α
E _{AS}	Single Pulsed Avalanche Energy (Note 2)		(Note 2)	50.4	mJ
dv/dt	Peak Diode Recovery dv/dt		(Note 3)	13.0	V/ns
D	Power Dissipation	(T _C = 25°C)		24	W
P_{D}	Power Dissipation	- Derate Above 25°C		0.19	W/°C
T _J , T _{STG}	Operating and Storage Tem	perature Range		-55 to +150	°C
T _L	Maximum Lead Temperatur	e for Soldering, 1/8" from Case for 5	Seconds	300	°C

Thermal Characteristics

Symbol	Parameter FDPF		Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	5.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	62.5	· C/VV

Datasheet of FDPF680N10T - MOSFET N-CH 100V 12A TO-220F

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FDPF680N10T	FDPF680N10T	TO-220F	Tube	N/A	N/A	50 units

Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu\text{A}, V_{GS} = 0 \text{V}, T_C = 25^{\circ}\text{C}$	100	-	-	V
ΔBV _{DSS} / ΔT _J	Breakdown Voltage Temperature Coefficient	I _D = 250 μA, Referenced to 25°C	-	0.1	-	V/°C
	Zero Gate Voltage Drain Current	V _{DS} = 100 V, V _{GS} = 0 V	-	-	1	
IDSS	Zero Gate voltage Drain Current	$V_{DS} = 100 \text{ V}, V_{GS} = 0 \text{ V}, T_{C} = 150^{\circ}\text{C}$	-	-	500	μА
I _{GSS}	Gate to Body Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V	-	-	±100	nA

On Characteristics

V _{GS(th)}	Gate Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu\text{A}$	2.5	3.5	4.5	V
R _{DS(on)}	Static Drain to Source On Resistance	V _{GS} = 10 V, I _D = 6 A	-	54	68	mΩ
g _{FS}	Forward Transconductance	V _{DS} = 10 V, I _D = 12 A	-	26	-	S

Dynamic Characteristics

C _{iss}	Input Capacitance	V 50.V.V 0.V	-	750	1000	pF
C _{oss}	Output Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1 MHz		60	80	pF
C _{rss}	Reverse Transfer Capacitance	1 10112	-\	25	40	pF
Q _{g(tot)}	Total Gate Charge		- \	13	17	nC
Q _{gs}	Gate to Source Gate Charge	$V_{DS} = 80 \text{ V}, I_{D} = 12 \text{ A},$	- \	4	-	nC
Q _{gd}	Gate to Drain "Miller" Charge	$V_{GS} = 10 \text{ V}$ (Note 4)	-	4	-	nC

Switching Characteristics

_						
t _{d(on)}	Turn-On Delay Time		-	13	36	ns
t _r		$V_{DD} = 50 \text{ V}, I_D = 12 \text{ A},$	-	19	48	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 10 V, R_G = 10 Ω	-	18	46	ns
t _f	Turn-Off Fall Time	(Note 4)	-	6	22	ns

Drain-Source Diode Characteristics

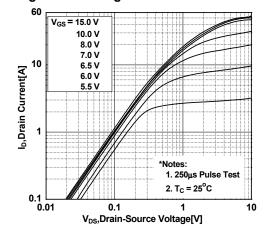
I _S	Maximum Continuous Drain to Source Diode Forward Current		-	-	12	Α
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	48	Α
V_{SD}	Drain to Source Diode Forward Voltage	V _{GS} = 0 V, I _{SD} = 12 A	-	-	1.3	V
t _{rr}	Reverse Recovery Time	V _{GS} = 0 V, I _{SD} = 12 A,	-	29	-	ns
Q _{rr}	Reverse Recovery Charge	dI _F /dt = 100 A/μs	-	35	_	nC

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. L = 0.7 mH, I $_{AS}$ = 12A, V $_{DD}$ = 50 V, R $_{G}$ = 25 Ω , starting T $_{J}$ = 25°C.
- 3. I $_{SD} \leq$ 12 A, di/dt \leq 200 A/µs, V $_{DD} \leq$ BV $_{DSS}$, starting T $_{J}$ = 25°C.
- 4. Essentially independent of operating temperature typical characteristics.



Typical Performance Characteristics

Figure 1. On-Region Characteristics



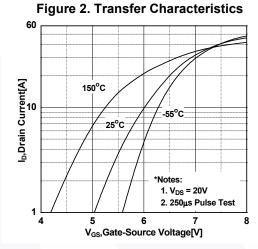
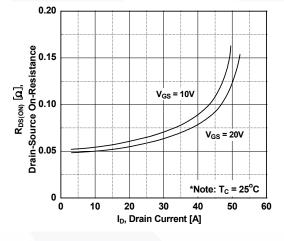


Figure 3. On-Resistance Variation vs.

Drain Current and Gate Voltage

Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature



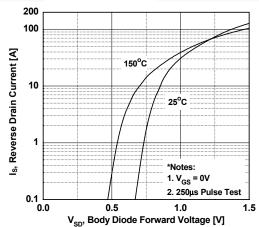


Figure 5. Capacitance Characteristics

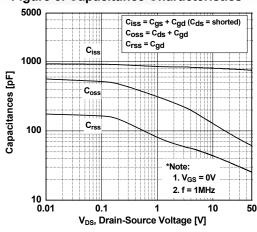
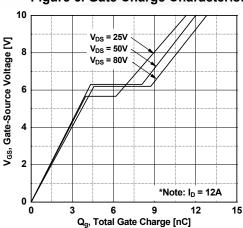


Figure 6. Gate Charge Characteristics





Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

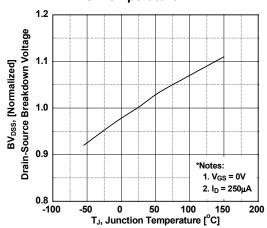


Figure 8. On-Resistance Variation vs. Temperature

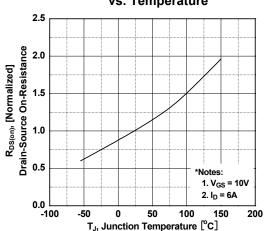


Figure 9. Maximum Safe Operating Area

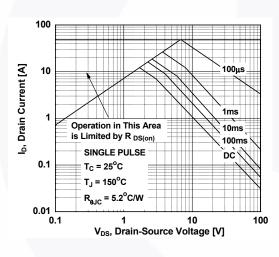


Figure 10. Maximum Drain Current vs. Case Temperature

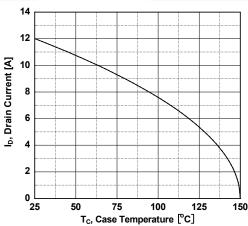
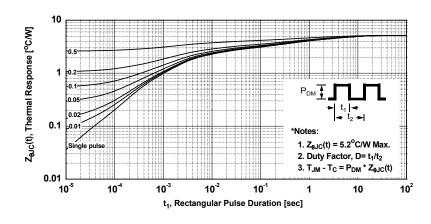


Figure 11. Transient Thermal Response Curve



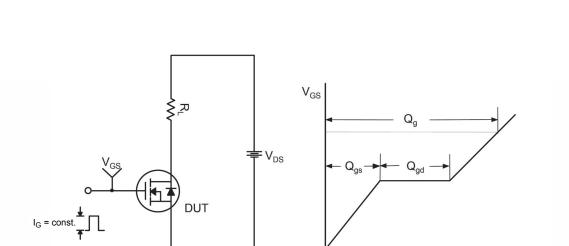


Figure 12. Gate Charge Test Circuit & Waveform

Charge

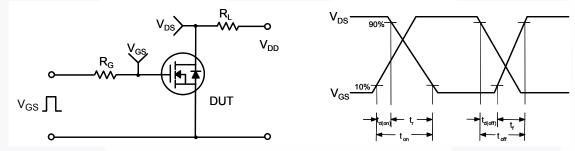


Figure 13. Resistive Switching Test Circuit & Waveforms

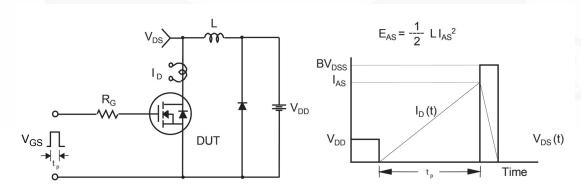
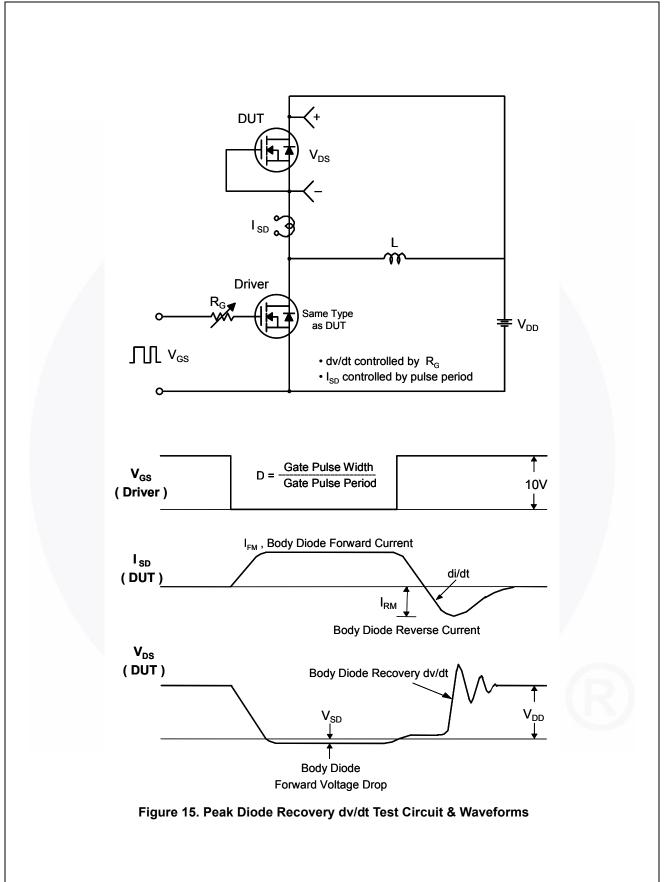


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms





Mechanical Dimensions

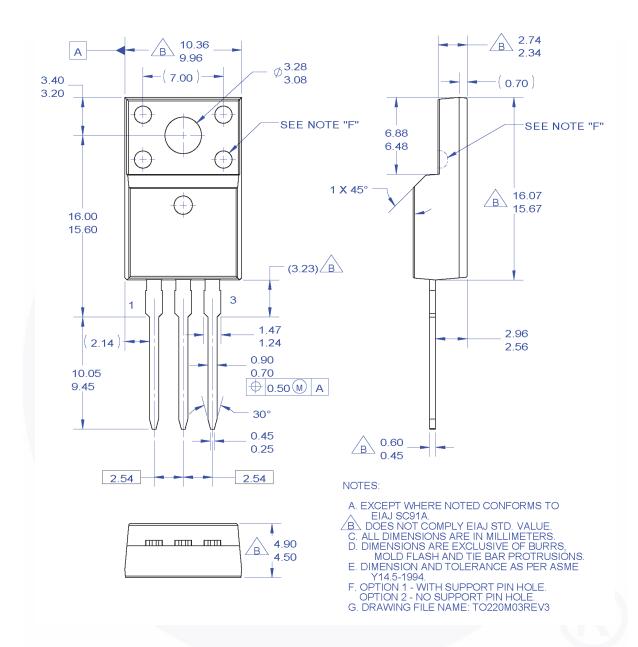


Figure 16. TO220, Molded, 3-Lead, Full Pack, EIAJ SC91, Straight Lead

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